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[^0]
## KA1M0565R/KA1H0565R <br> Fairchild Power Switch(FPS)

## Features

- Precision fixed operating frequency
- KA1M0565R (67KHz),KA1H0565R (100KHz)
- Pulse by pulse over current limiting
- Over load protection
- Over voltage protection (Min. 23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- Auto restart


## Description

The Fairchild Power Switch(FPS) product family is specially designed for an off-line SMPS with minimal external components. The Fairchild Power Switch(FPS) consist of high voltage power SenseFET and current mode PWM controller IC. PWM controller features integrated fixed oscillator, under voltage lock out, leading edge blanking, optimized gate turn-on/turn-off driver, thermal shut down protection, over voltage protection, temperature compensated precision current sources for loop compensation and fault protection circuit. compared to discrete MOSFET and controller or RCC switching converter solution, a Fairchild Power Switch(FPS) can reduce total component count, design size, weight and at the same time increase \& efficiency, productivity, and system reliability. It has a basic platform well suited for cost effective design in either a flyback converter or a forward converter.

## TO-220F-4L



1. GND 2. DRAIN 3. VCC 4. FB

## Internal Block Diagram



Rev.1.0.2

## Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Maximum Drain voltage ${ }^{(1)}$ | VD,MAX | 650 | V |
| Drain Gate voltage (RGS $=1 \mathrm{M} \Omega)$ | VDGR | 650 | V |
| Gate-source (GND) voltage | VGS | $\pm 30$ | V |
| Drain current pulsed ${ }^{(2)}$ | IDM | 20 | ADC |
| Single pulsed avalanche energy ${ }^{(3)}$ | EAS | 230 | mJ |
| ${\text { Continuous drain current }\left(\mathrm{TC}=25^{\circ} \mathrm{C}\right)}^{\text {Continuous drain current }\left(\mathrm{TC}=100^{\circ} \mathrm{C}\right)}$ ID | 5.0 | ADC |  |
| Maximum Supply voltage | ID | 3.5 | ADC |
| Input voltage range | VCC,MAX | 30 | V |
| Total power dissipation | VFB | -0.3 to VSD | V |
|  | PD | 140 | W |
| Storage temperature | Derating | 1.11 | $\mathrm{~W} /{ }^{\circ} \mathrm{C}$ |

## Notes:

1. $\mathrm{Tj}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
2. Repetitive rating: Pulse width limited by maximum junction temperature
3. $\mathrm{L}=30 \mathrm{mH}, \mathrm{V} D \mathrm{D}=50 \mathrm{~V}, \mathrm{RG}=27 \Omega$, starting $\mathrm{Tj}=25^{\circ} \mathrm{C}$

## Electrical Characteristics (SFET part)

( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain source breakdown voltage | BVDSS | VGS=0V, ID=50 $\mu \mathrm{A}$ | 650 | - | - | V |
| Zero gate voltage drain current | IDSS | VDS=Max., Rating, VGS=0V | - | - | 50 | $\mu \mathrm{A}$ |
|  |  | VDS $=0.8 \mathrm{Max} .$, Rating, <br> VGS $=0 \mathrm{~V}, \mathrm{TC}=125^{\circ} \mathrm{C}$ | - | - | 200 | $\mu \mathrm{A}$ |
| Static drain source on resistance ${ }^{\text {(note) }}$ | RDS(ON) | VGS $=10 \mathrm{~V}, \mathrm{ID}=2.5 \mathrm{~A}$ | - | 1.76 | 2.2 | $\Omega$ |
| Forward transconductance ${ }^{\text {(note) }}$ | gfs | VDS $=50 \mathrm{~V}, \mathrm{ID}=2.5 \mathrm{~A}$ | 2.5 | - | - | S |
| Input capacitance | Ciss | $\begin{aligned} & \text { VGS=0V, VDS=25V, } \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ | - | 1457 | - | pF |
| Output capacitance | Coss |  | - | 130 | - |  |
| Reverse transfer capacitance | Crss |  | - | 38.8 | - |  |
| Turn on delay time | td(on) | VDD=0.5BVDSS, ID=5.0A (MOSFET switching time are essentially independent of operating temperature) | - | - | 60 | nS |
| Rise time | tr |  | - | - | 150 |  |
| Turn off delay time | td(off) |  | - | - | 300 |  |
| Fall time | tf |  | - | - | 130 |  |
| Total gate charge (gate-source+gate-drain) | Qg | $\text { VGS }=10 \mathrm{~V}, \mathrm{ID}=5.0 \mathrm{~A},$ <br> VDS=0.5BVDSS (MOSFET <br> switching time are essentially independent of operating temperature) | - | - | 56 | nC |
| Gate source charge | Qgs |  | - | 10.3 | - |  |
| Gate drain (Miller) charge | Qgd |  | - | 22.3 | - |  |

## Note:

Pulse test: Pulse width $\leq 300 \mu \mathrm{~S}$, duty cycle $\leq 2 \%$ $S=\frac{1}{R}$

## Electrical Characteristics (CONTROL part)

( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| UVLO SECTION |  |  |  |  |  |  |
| Start threshold voltage | VSTART | - | 14 | 15 | 16 | V |
| Stop threshold voltage | VSTOP | After turn on | 9 | 10 | 11 | V |
| OSCILLATOR SECTION |  |  |  |  |  |  |
| Initial accuracy | Fosc | KA1M0565R | 61 | 67 | 73 | kHz |
|  |  | KA1H0565R | 90 | 100 | 110 |  |
| Frequency change with temperature ${ }^{(2)}$ | $\Delta \mathrm{F} / \Delta \mathrm{T}$ | $-25^{\circ} \mathrm{C} \leq \mathrm{Ta} \leq+85^{\circ} \mathrm{C}$ | - | $\pm 5$ | $\pm 10$ | \% |
| Maximum duty cycle | Dmax | KA1M0565R | 74 | 77 | 80 | \% |
|  |  | KA1H0565R | 64 | 67 | 70 |  |
| FEEDBACK SECTION |  |  |  |  |  |  |
| Feedback source current | IFB | $\mathrm{Ta}=25^{\circ} \mathrm{C}, 0 \mathrm{~V} \leq \mathrm{Vfb} \leq 3 \mathrm{~V}$ | 0.7 | 0.9 | 1.1 | mA |
| Shutdown Feedback voltage | VSD | - | 6.9 | 7.5 | 8.1 | V |
| Shutdown delay current | Idelay | $\mathrm{Ta}=25^{\circ} \mathrm{C}, 5 \mathrm{~V} \leq \mathrm{Vfb} \leq \mathrm{V}$ SD | 4.0 | 5.0 | 6.0 | $\mu \mathrm{A}$ |
| REFERENCE SECTION |  |  |  |  |  |  |
| Output voltage ${ }^{(1)}$ | Vref | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 4.80 | 5.00 | 5.20 | V |
| Temperature Stability ${ }^{(1)(2)}$ | Vref/ $\Delta$ T | $-25^{\circ} \mathrm{C} \leq \mathrm{Ta} \leq+85^{\circ} \mathrm{C}$ | - | 0.3 | 0.6 | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| CURRENT LIMIT (SELF-PROTECTION) SECTION |  |  |  |  |  |  |
| Peak Current Limit | IOVER | Max. inductor current | 3.08 | 3.5 | 3.92 | A |
| PROTECTION SECTION |  |  |  |  |  |  |
| Thermal shutdown temperature (Tj) ${ }^{(1)}$ | TSD | - | 140 | 160 | - | ${ }^{\circ} \mathrm{C}$ |
| Over voltage protection voltage | VovP | - | 23 | 25 | 28 | V |
| TOTAL DEVICE SECTION |  |  |  |  |  |  |
| Start Up current | ISTART | VCC=14V | 0.1 | 0.3 | 0.4 | mA |
| Operating supply current (control part only) | IOP | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 6 | 12 | 18 | mA |
| VCC zener voltage | VZ | $\mathrm{ICC}=20 \mathrm{~mA}$ | 30 | 32.5 | 35 | V |

## Note:

1. These parameters, although guaranteed, are not $100 \%$ tested in production
2. These parameters, although guaranteed, are tested in EDS (wafer test) process

## Typical Performance Characteristics

(These characteristic graphs are normalized at $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )


Figure 1. Operating Frequency


Figure 3. Operating Supply Current


Figure 5. Start up Current


Figure 2. Feedback Source Current


Figure 4. Peak Current Limit


Figure 6. Start Threshold Voltage

## Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )


Figure 7. Stop Threshold Voltage


Figure 9. Vcc Zener Voltage


Figure 11. Shutdown Delay Current


Figure 8. Maximum Duty Cycle


Figure 10. Shutdown Feedback Voltage


Figure 12. Over Voltage Protection

## Typical Performance Characteristics (Continued)

(These characteristic grahps are normalized at $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )


Figure 13. Static Drain-Source on Resistance

## Package Dimensions

## TO-220F-4L



## Package Dimensions (Continued)

## TO-220F-4L(Forming)



## Ordering Information

| Product Number | Package | Rating | Fosc |
| :--- | :---: | :---: | :---: |
| KA1M0565R-TU | TO-220F-4L | $650 \mathrm{~V}, 5 \mathrm{~A}$ | 67 kHz |
| KA1M0565R-YDTU | TO-220F-4L(Forming) |  |  |
| KA1H0565R-TU | TO-220F-4L | $650 \mathrm{~V}, 5 \mathrm{~A}$ | 100 kHz |
| KA1H0565R-YDTU | TO-220F-4L(Forming) |  |  |

TU : Non Forming Type
YDTU : Forming Type

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#### Abstract

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